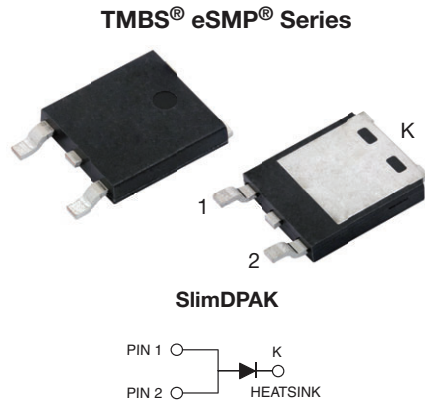


# High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

 Ultra Low  $V_F = 0.42\text{ V}$  at  $I_F = 5\text{ A}$ 


## FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** SlimDPAK

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

| PRIMARY CHARACTERISTICS                                |            |
|--|------------|
| $I_{F(AV)}$  | 35 A       |
| $V_{RRM}$  | 120 V      |
| $I_{FSM}$  | 260 A      |
| $V_F$ at $I_F = 35\text{ A}$ ( $T_A = 125\text{ °C}$ ) | 0.68 V     |
| $T_J$ max.   | 175 °C     |
| Package  | SlimDPAK   |
| Diode variation  | Single die |

| MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)                     |                   |             |      |
|--|-------------------|-------------|------|
| PARAMETER  | SYMBOL            | V35PWM12    | UNIT |
| Device marking code  |                   | V35PWM12    |      |
| Maximum repetitive peak reverse voltage  | $V_{RRM}$         | 120         | V    |
| Maximum average forward rectified current (Fig. 1)                                 | $I_{F(AV)}^{(1)}$ | 35          | A    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$         | 260         | A    |
| Operating junction and storage temperature range                                   | $T_J, T_{STG}$    | -40 to +175 | °C   |

### Note

<sup>(1)</sup> With infinite heat sink



| <b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                       |                                   |             |      |      |      |
|--|-----------------------|-----------------------------------|-------------|------|------|------|
| PARAMETER  | TEST CONDITIONS       |                                   | SYMBOL      | TYP. | MAX. | UNIT |
| Maximum Instantaneous forward voltage  | $I_F = 5.0\text{ A}$  | $T_A = 25\text{ }^\circ\text{C}$  | $V_F^{(1)}$ | 0.51 | -    | V    |
|  | $I_F = 17.5\text{ A}$ |                                   |             | 0.72 | -    |      |
|  | $I_F = 35\text{ A}$   |                                   |             | 0.96 | 1.05 |      |
|  | $I_F = 5.0\text{ A}$  | $T_A = 125\text{ }^\circ\text{C}$ |             | 0.42 | -    |      |
|  | $I_F = 17.5\text{ A}$ |                                   |             | 0.59 | -    |      |
|  | $I_F = 35\text{ A}$   |                                   |             | 0.68 | 0.76 |      |
| Reverse current  | $V_R = 90\text{ V}$   | $T_A = 25\text{ }^\circ\text{C}$  | $I_R^{(2)}$ | 0.01 | -    | mA   |
|  |                       | $T_A = 125\text{ }^\circ\text{C}$ |             | 7    | -    |      |
|  | $V_R = 120\text{ V}$  | $T_A = 25\text{ }^\circ\text{C}$  |             | -    | 1.2  |      |
|  |                       | $T_A = 125\text{ }^\circ\text{C}$ |             | 13   | 40   |      |
| Typical junction capacitance   | 4.0 V, 1 MHz          |                                   | $C_J$       | 2080 | -    | pF   |

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: pulse width  $\leq 5\text{ ms}$

| <b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                          |          |                    |
|---|--------------------------|----------|--------------------|
| PARAMETER   | SYMBOL                   | V35PWM12 | UNIT               |
| Typical thermal resistance  | $R_{\theta JA}^{(1)(2)}$ | 55       | $^\circ\text{C/W}$ |
|   | $R_{\theta JM}^{(3)}$    | 1.5      |                    |

**Notes**

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
(2) Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
(3) Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount

| <b>ORDERING INFORMATION</b> (Example) |                 |                        |               |                                    |
|---------------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                         | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| V35PWM12-M3/I                         | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |
| V35PWM12HM3/I <sup>(1)</sup>          | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

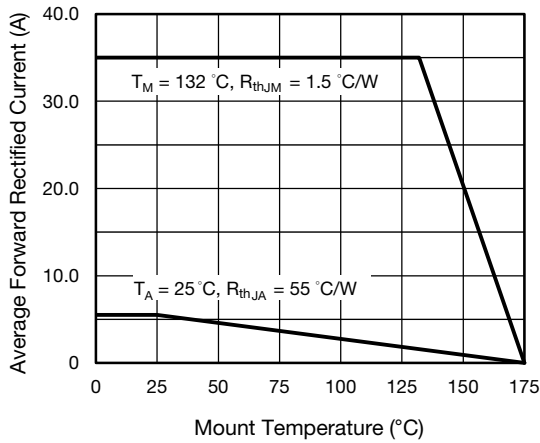


Fig. 1 - Maximum Forward Current Derating Curve

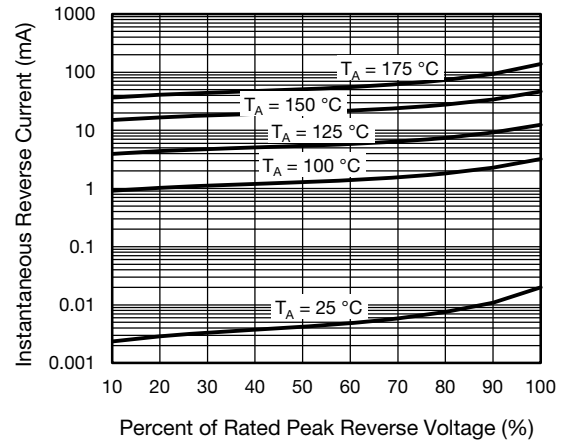


Fig. 4 - Typical Reverse Leakage Characteristics

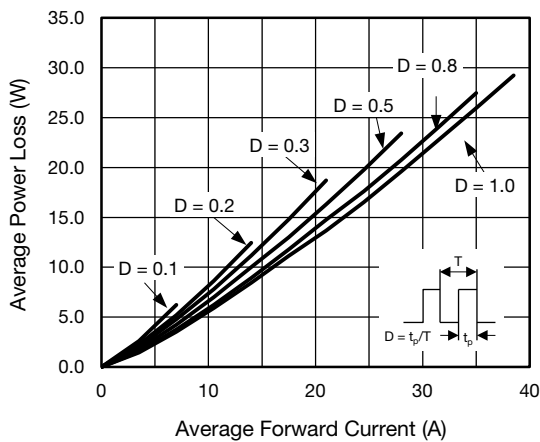


Fig. 2 - Forward Power Loss Characteristics

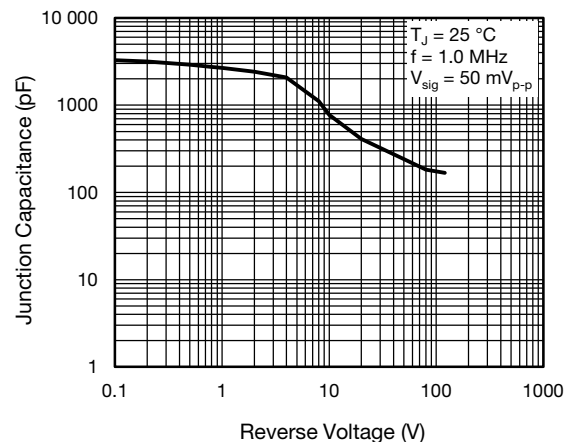


Fig. 5 - Typical Junction Capacitance

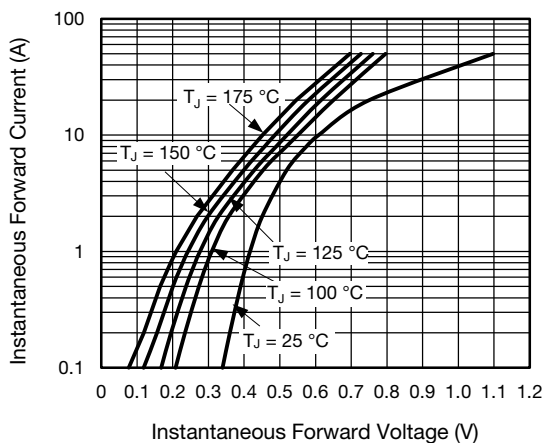


Fig. 3 - Typical Instantaneous Forward Characteristics

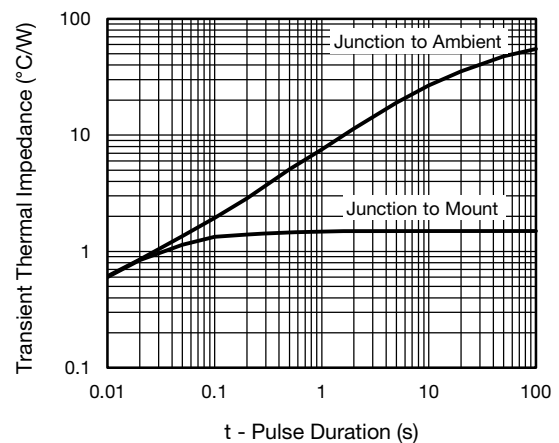
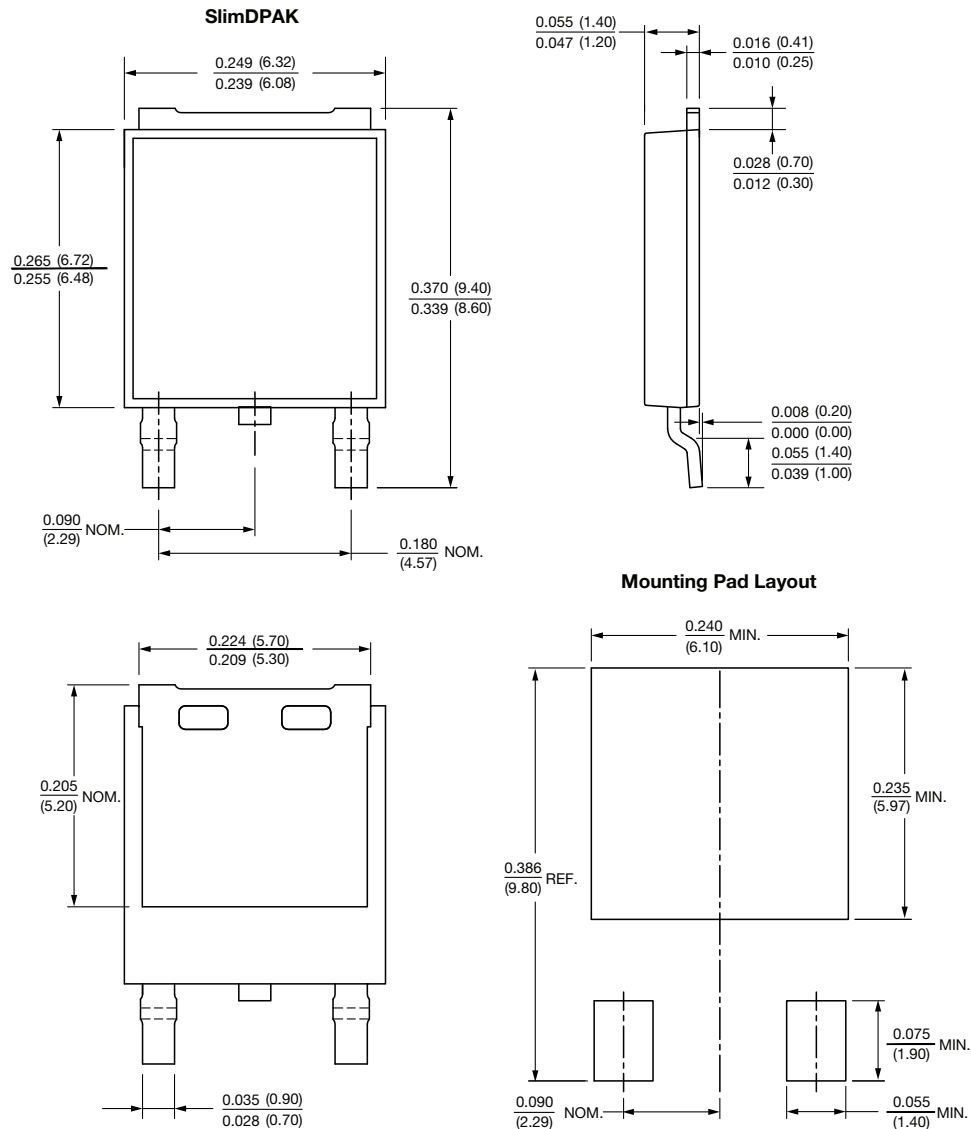


Fig. 6 - Typical Transient Thermal Impedance



Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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